In re: Shin et al.

Serial No.: 10/606,048 Filed: June 25, 2003

Page 2 of 6

In the Specification:

Please replace the paragraph at page 3, line 17, with the following paragraph:

In some embodiments, the floor is directly on the substrate. In some embodiments, the second conductive contact fills the second hole and the groove. In some embodiments, the first conductive contact comprises a first barrier layer on the sidewall and floor, and a first conductive layer on the first barrier layer remote from the sidewall. In some embodiments, the second conductive contact also comprises a second barrier layer on the first conductive layer, and a second conductive layer on the second barrier layer remote from the first conductive layer. In some embodiments, the first conductive contact also extends onto the first insulating layer outside the first hole and, in some embodiments, the second conductive contact also extends onto the second insulating layer outside the second hole.

Please replace the paragraph at page 6, line 25, with the following paragraph:

In still other embodiments, a third insulating layer 150 is provided on the second insulating layer 136 remote from the first insulating layer 120 that includes therein a sixth hole 154 that exposes the second [[hold]] hole 138. The second conductive contact 160 further extends into the sixth hole 154.